WHAT IS CLAIMED IS:

- 1. A charged particle beam exposure system which draws a pattern on an object to be exposed by a plurality of charged particle beams, said system comprising:
 - (a) a storage device storing:
- (i) standard dose data for controlling the irradiation of charged particle beams to an object to be exposed,
- (ii) plural pieces of proximity effect correction data for correcting the irradiation of the charged particle beams for each incidence position with respect to the object to be exposed, in order to reduce the influence of a proximity effect; and
- (iii) calibration data for correcting variations in the irradiation dose among a plurality of the charged particle beams; and
- (b) a controller for controlling the irradiation of each of the charged particle beams, based on the standard dose data, the proximity effect correction data, and the calibration data.

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2. A charged particle beam exposure system as claimed in claim 1, wherein the standard dose data includes bit map data which is determined depending on the pattern to be



exposed.

- 3. A charged particle beam exposure system as claimed in claim 1, wherein the standard dose data includes the data defining the bit map data and a ratio of the irradiation time with respect to the non-irradiation time.
- 4. A charged particle beam exposure system as claimed in claim 1, further comprising obtaining means for obtaining the calibration data by measuring variations in the irradiation dose among a plurality of the charged particle beams.
- 5. A charged particle beam exposure system as claimed in claim 4, wherein said obtaining means includes a Faraday cup.
- 6. A charged particle beam exposure system as claimed in claim 1, further comprising selecting means for selecting one piece of data suitable for the proximity effect correction with respect to the standard dose data, from plural pieces of the proximity effect correction data stored in said memory device.
 - 7. A method for correcting exposure data for drawing a

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determining the calibration data of each of the element electron optical systems, based on the irradiation dose measured in said measuring step.

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- 8. A method for correcting exposure data as claimed in claim 7, wherein whether the selected one piece of proximity effect correction data is the optimum data for controlling the standard dose data is judged by comparing the exposed pattern and the standard pattern by a visual inspection.
- 9. A method for correcting exposure data as claimed in claim 7, wherein whether the selected one piece of proximity effect correction data is the optimum data for controlling the standard dose data is judged by evaluating means for comparing the exposed pattern and the standard pattern.
- 10. A method for correcting exposure data as claimed in claim 7, wherein the standard dose data includes bit map data which is determined depending on the pattern to be exposed.
- 11. A method for correcting exposure data as claimed in claim 7, wherein the standard dose data includes the data defining the bit map data and the ratio of the irradiation time with respect to the non-irradiation time.

12. A method for correcting exposure data as claimed in claim 7, wherein the proximity effect correction data is data not depending on the pattern to be exposed, but depending on the conditions of the object to be exposed.

- 13. A method for correcting exposure data as claimed in claim 12, wherein the conditions are determined as at least one parameter among the foundamental conditions of the object to be exposed, the resist material, and a backward-scattering radius.
- 14. A method for correcting exposure data as claimed in claim 7, wherein the sensor in said measuring step includes a Faraday cup.
- 15. A method for manufacturing a device, comprising the steps of:

providing an exposure system as claimed in any one of claims 1 through 5;

exposing a pattern on a wafer using the exposure system; and

assembling a device by processing the wafer on which the pattern has been exposed.

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pattern on an object to be exposed by a plurality of charged particle beams emitted from a plurality of element electron optical systems, said method comprising the steps of:

creating standard dose data for each irradiation position of the charged particle beams in order to expose a standard pattern on the object to exposed;

creating of renewing a plurality of the proximity effect correction data for each irradiation position, depending on conditions of the object to be exposed;

selecting any one piece of the proximity effect correction data, from plural pieces of the proximity effect correction data for each irradiation position;

performing a proximity effect correction with respect to the standard dose data based on the selected data, and exposing a pattern on the object to be exposed;

evaluating the exposed pattern, and judging whether the selected one piece of proximity effect correction data is the optimum data for controlling the standard dose data;

determining the optimum proximity effect correction data for controlling the standard dose data in accordance with the judgment;

measuring, by a sensor, the irradiation dose of the charged particle beams from each element electron optical system, the irradiation dose having been subjected to a correction by the proximity effect correction data; and